



9/12

FIG.9 (a)
 PRIOR ART

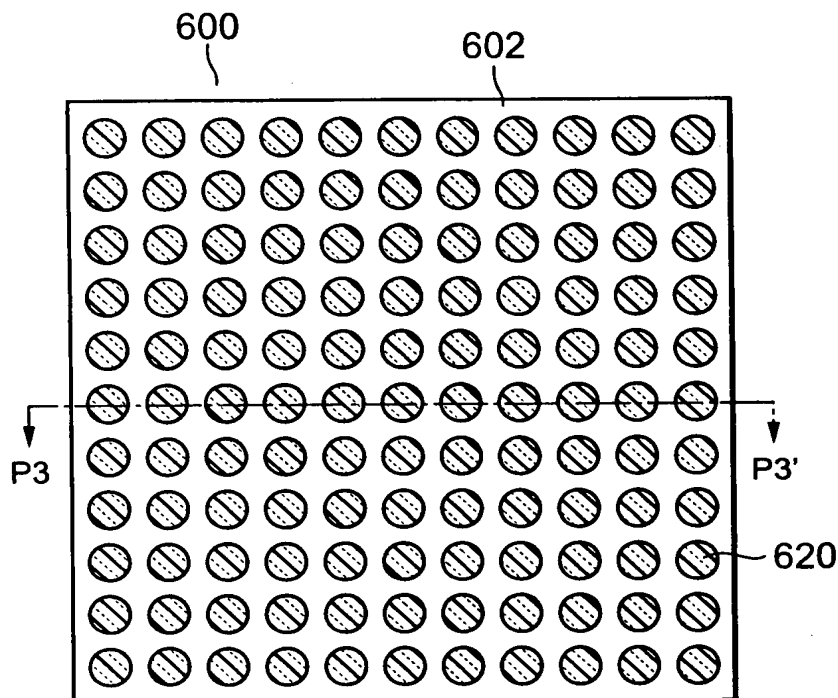


FIG.9 (b)
 PRIOR ART

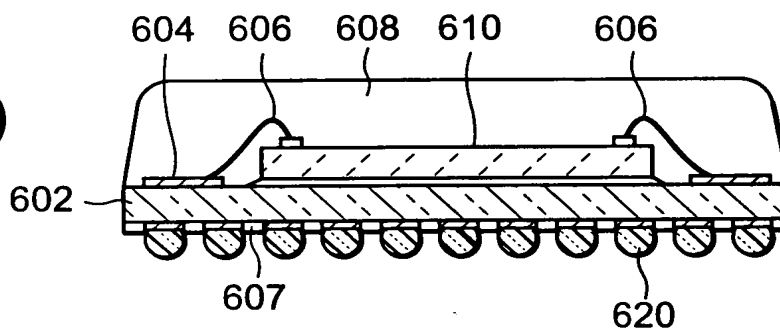
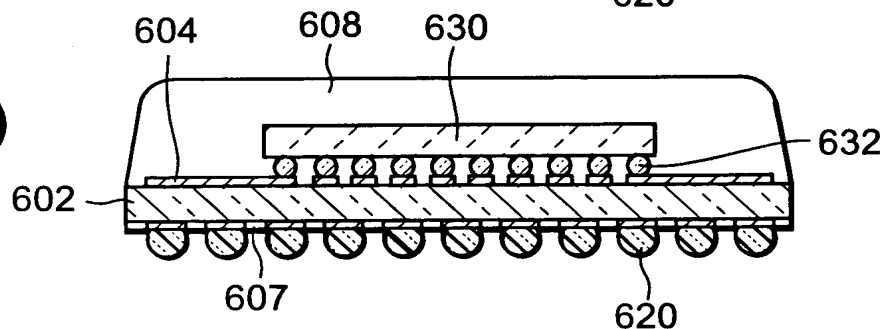


FIG.9 (c)
 PRIOR ART



- | | |
|---------------------|---------------------------|
| 600 BGA TYPE LSI | 620 FIRST BUMP ELECTRODE |
| 602 PRINTED BOARD | 632 SECOND BUMP ELECTRODE |
| 604 BOARD WIRING | |
| 606 METAL WIRE | |
| 607 INSULATING FILM | |
| 608 SEALING RESIN | |
| 610,630 CHIP | |